





# ORG4572-MK05

# **GPS / GNSS RECEIVER MODULE**

# Datasheet

OriginGPS.com





# **TABLE OF CONTENTS**

1.	ABOUT	UT SPIDER MODULES 1		
2.	ABOUT	ORIGING	PS	2
3.	DESCRI	PTION		3
	3.1.	Features		
	3.2.	Architec	ture	4
	3.3.	ORG457	2-MK05 Features Description:	7
		3.3.1.	Constellation Configuration	7
		3.3.2.	1PPS	7
		3.3.3.	Static Navigation	7
		3.3.4.	Assisted GPS (AGPS)	7
		3.3.5.	Quasi-Zenith Satellite System (QZSS)	9
		3.3.6.	Satellite-Based Augmentation System (SBAS)	9
		3.3.7.	Differential GPS (DGPS)	9
		3.3.8.	Jamming Rejection – Active Interference Cancellation (AIC)	9
		3.3.9.	Power Management Modes1	0
		3.3.10.	Configuration Settings1	4
	3.4.	Pad Assi	ignment1	5
4.	MECHA	NICAL SP	ECIFICATIONS1	17
5.	ELECTR	RICAL SPE	CIFICATIONS1	8
	5.1.	Absolute	e Maximum Ratings1	.8
	5.2.	Recomm	nended Operating Conditions1	9
6.	PERFOR	RMANCE .	2	20
	6.1.	Acquisiti	on Time2	20
		6.1.1.	Hot Start2	20
		6.1.2.	Signal Reacquisition2	20
		6.1.3.	Aided Start2	20
		6.1.4.	Warm Start2	20
		6.1.5.	Cold Start2	20
	6.2.	Sensitivi	ty2	21
		6.2.1.	Tracking2	21
		6.2.2.	Reacquisition2	21
		6.2.3.	Navigation2	21
		6.2.4.	Hot Start2	21
		6.2.5.	Aided Start2	22
		6.2.6.	Cold Start2	22



	6.3.	Received Signal Strength	22
	6.4.	Power Consumption	23
	6.5.	Position Accuracy	23
	6.6.	Dynamic Constraints	23
7.	INTERF	ACE2	<u>2</u> 4
	7.1.	Power Supply2	<u>2</u> 4
		7.1.1. Nominal VCC = 3.3V	24
		7.1.2. Ground	<u>2</u> 4
	7.2.	Control Interface	<u>2</u> 4
		7.2.1. UART—Host Interface	<u>2</u> 4
		7.2.2. I2C	25
		7.2.3. SPI	25
		7.2.4. Data Interface	26
8.	TYPICA	L APPLICATION CIRCUIT	<u>28</u>
9.	RECOM	MENDED PCB LAYOUT2	<u>29</u>
	9.1.	Footprint2	<u>29</u>
	9.2.	RF Trace	30
	9.3.	PCB Stack-Up	30
	9.4.	PCB Layout Restrictions	31
10.	DESIGN	I CONSIDERATIONS	32
	10.1.	Antenna	32
		10.1.1. Passive Antenna	32
		10.1.2. Active Antenna	32
	10.2.	RF	32
11.	FIRMW	ARE UPDATES	34
12.	HANDLI	ING INFORMATION	35
	12.1.	Moisture Sensitivity	35
	12.2.	Assembly	35
	12.3.	Soldering	35
	12.4.	Cleaning	37
	12.5.	Rework	37
	12.6.	ESD Sensitivity	37
	12.7.	Safety Information	37
	12.8.	Disposal Information	37
13.	COMPLI	ANCE	38
14.	PACKAG	SING AND DELIVERY	39
	14.1.	Appearance	39
	14.2.	Carrier Tape4	<del>1</del> 0



	14.3.	Reel	41		
15.	15. ORDERING INFORMATION				
Appe	ndix A.	ORG4572-MK05	43		





# **LIST OF FIGURES**

Figure 1. ORG4572-MK05 Architecture	
Figure 2. MT3333 System Block Diagram and Peripheral	5
Figure 3. Easy™ TTFF Timing	
Figure 4. Periodic Power Saving Mode	11
Figure 5. AlwaysLocate <sup>™</sup> Mode: Power vs. Time	12
Figure 6. ORG4572-MK05 Top View	16
Figure 7. Mechanical Drawing	17
Figure 8. 1PPS and UTC	27
Figure 9. Reference Schematic Diagram	28
Figure 10. Footprint	29
Figure 11. Module Hosted on Footprint	29
Figure 12. Host PCB	30
Figure 13. Typical Microstrip PCB Trace on Fr-4 Substrate	30
Figure 14. Typical PCB Stack-Up	30
Figure 15. Recommended Soldering Profile	36
Figure 16. Module Position	
Figure 17. Carrier Tape	40
Figure 18. Reel	41
Figure 19. Ordering Options	42
Figure 20. Battery Backup Implementation	43





# LIST OF TABLES

Table 1. Pin-Out	15
Table 2. Mechanical Summary	17
Table 3. Absolute Maximum Ratings	18
Table 4. Recommended Operating Conditions	19
Table 5. Acquisition Time	21
Table 6. Sensitivity	22
Table 7. Received Signal Strength	22
Table 8. Power Consumption	23
Table 9. ORG4572-MK05 Position Accuracy	23
Table 10. Dynamic Constraints	
Table 11. NMEA Input Commands	33
Table 12. Soldering Profile Parameters	
Table 13. Reel Quantity	39
Table 14. Carrier Tape Dimensions	40
Table 15. Reel Dimensions	41
Table 16. Orderable Devices	42





# TABLE OF REVISIONS

Ver. #	Description	Author/s	Date
1.0	First Release	lgor M.	November 3, 2021
1.1	Update FORCE_ON, Added SPI, updated V_backup, updated reference design, supply voltage ripple, accuracy (CEP)	Mark R.	May 24, 2022





# **ABBREVIATIONS**

Abbreviation	Description		
A-GPS	Assisted GPS		
AC	Alternating Current		
ADC	Analog to Digital Converter		
AGC	Automatic Gain Control		
BPF	Band Pass Filter		
C/N₀	Carrier-to-Noise density ratio [dB-Hz]		
CDM	Charged Device Model		
CE	European Community conformity mark		
СЕР	Circular Error Probability		
CMOS	Complementary Metal-Oxide Semiconductor		
CPU	Central Processing Unit		
CTS	Clear-to-Send		
CW	Continuous Wave		
DC	Direct Current		
DOP	Dilution of Precision		
DR	Dead Reckoning		
DSP	Digital Signal Processor		
ECEF	Earth-Centered Earth-Fixed		
ЕСНА	European Chemical Agency		
EGNOS	European Geostationary Navigation Overlay Service		
EIA	Electronic Industries Alliance		
EMC	Electro-Magnetic Compatibility		
EMI	Electro-Magnetic Interference		
ENIG	Electroless Nickel Immersion Gold		
ESD	Electro-Static Discharge		
ESR	Equivalent Series Resistance		
EU	European Union		
EVB	Evaluation Board		



Abbreviation	Description		
EVK	Evaluation Kit		
FCC	Federal Communications Commission		
FSM	Finite State Machine		
GAGAN	GPS Aided Geo-Augmented Navigation		
GNSS	Global Navigation Satellite System		
GPIO	General Purpose Input or Output		
GPS	Global Positioning System		
НВМ	Human Body Model		
HDOP	Horizontal Dilution of Precision		
I <sup>2</sup> C	Inter-Integrated Circuit		
1/0	Input or Output		
IC	Integrated Circuit		
ICD	Interface Control Document		
IF	Intermediate Frequency		
ISO	International Organization for Standardization		
JEDEC	Joint Electron Device Engineering Council		
КА	Keep Alive		
KF	Kalman Filter		
LDO	Low Dropout regulator		
LGA	Land Grid Array		
LNA	Low Noise Amplifier		
LP	Low Power		
LS	Least Squares		
LSB	Least Significant Bit		
MID	Message Identifier		
ММ	Machine Model		
MSAS	Multi-functional Satellite Augmentation System		
MSB	Most Significant Bit		
MSL	Moisture Sensitivity Level		
NFZ™	Noise-Free Zones System		



Abbreviation	Description		
NMEA	National Marine Electronics Association		
NVM	Non-Volatile Memory		
РСВ	Printed Circuit Board		
PLL	Phase Lock Loop		
PMU	Power Management Unit		
POR	Power-On Reset		
PPS	Pulse per Second		
PRN	Pseudo-Random Noise		
PSRR	Power Supply Rejection Ratio		
PTF™	Push-to-Fix		
QZSS	Quasi-Zenith Satellite System		
RAM	Random Access Memory		
REACH	Registration, Evaluation, Authorization, and Restriction of Chemical substances		
RF	Radio Frequency		
RHCP	Right-Hand Circular Polarized		
RMS	Root Mean Square		
RoHS	Restriction of Hazardous Substances directive		
ROM	Read-Only Memory		
RTC	Real-Time Clock		
RTS	Ready-to-Send		
SAW	Surface Acoustic Wave		
SBAS	Satellite-Based Augmentation Systems		
SID	Sub-Identifier		
SIP	System in Package		
SMD	Surface-Mounted Device		
SMPS	Switched-Mode Power Supply		
SMT	Surface-Mount Technology		
SOC	System-On Chip		
SPI	Serial Peripheral Interface		
SV	Satellite Vehicle		



Abbreviation	Description	
тсхо	Temperature-Compensated Crystal Oscillator	
TTFF	Time to First Fix	
TTL	Transistor-Transistor Logic	
UART	Universal Asynchronous Receiver/Transmitter	
VCCI	Voluntary Control Council for Interference by information technology equipment	
VEP	Vertical-Error Probability	
VGA	Variable-Gain Amplifier	
WAAS	Wide Area Augmentation System	





# **RELATED DOCUMENTS**

Ver. #	Description	
1	Spider – ORG4572-MK05 Evaluation Kit Datasheet	
2	MTK NMEA Manual Packet	
3	MTK_SPI application notes	





# SCOPE

This document describes the features and specifications of the ORG4572-MK05 GNSS module.

# DISCLAIMER

All trademarks are properties of their respective owners.

Performance characteristics listed in this document do not constitute a warranty or guarantee of product performance. OriginGPS assumes no liability or responsibility for any claims or damages arising out of the use of this document, or from the use of integrated circuits based on this document. OriginGPS assumes no liability or responsibility for unintentional inaccuracies or omissions in this document. OriginGPS reserves the right to make changes in its products, specifications, and other information at any time without notice.

OriginGPS reserves the right to conduct, from time to time, and at its sole discretion, firmware upgrades.

As long as those FW improvements have no material change on end customers, PCN may not be issued.

OriginGPS navigation products are not recommended to use in life-saving or life-sustaining applications.

# **SAFETY INFORMATION**

Improper handling and use can cause permanent damage to the product.

# **ESD SENSITIVITY**

This product is ESD sensitive device and must be handled with care.



# **CONTACT INFORMATION**

contactus@origingps.com

www.origingps.com



# **1. ABOUT SPIDER MODULES**

Spider modules are a complete SiP featuring miniature LGA SMT footprint designed to commit unique integration features for high volume, cost sensitive applications.

Designed to support compact and traditional applications such as smart watches, wearable devices, asset trackers, the Spider module ORG4572-MK05 is a miniature multi-channel GPS, Galileo and GLONASS/BEIDOU, SBAS, and QZSS overlay systems receiver that continuously tracks all satellites in view, providing real-time positioning data in industry-standard NMEA format.

The Spider module ORG4572-MK05 offers superior sensitivity and outstanding performance, achieving rapid TTFF in less than one second, with accuracy of approximately two meters, and tracking sensitivity of -165dBm.

Sized at only 7mm x 7mm, the Spider module ORG4572-MK05 is the industry's small sized, record-breaking solution.

The Spider module ORG4572-MK05 introduces industry's lowest energy-perfix ratio, unparalleled accuracy, and extremely fast fixes even under challenging signal conditions, such as in built-up urban areas, dense foliage, or even indoors.

The integrated GPS SoC incorporating high-performance microprocessor and sophisticated firmware keeps positioning payload off the host, enabling the integration in embedded solutions with low computing resources.

Innovative architecture can detect changes in context, temperature, and satellite signals to achieve a state of near continuous availability by maintaining and opportunistically updating its internal fine time, frequency, and satellite ephemeris data, while consuming mere microwatts of battery power.





OriginGPS develops, manufactures, and supplies the world's smallest GNSS and cellular IoT solutions.

Our high-performance miniature GNSS products provide multiple constellation support to help you track everything valuable to you and your business. The OriginIoT<sup>™</sup> makes IoT-enabling devices affordable and accessible by eliminating the need for additional embedded software and RF engineering knowhow. The low power cellular IoT system reduces project costs and dramatically shortens time-to-market when you develop cellular IoT devices.

OriginGPS miniature products are ideal for market verticals, such as asset tracking, fleet management, industrial IoT, law enforcement, pet/people tracking, precision agriculture, smart cities, sports, and wearables.





### 3.1. Features

- Autonomous operation
- OriginGPS Noise Free Zone System technology
- Active or passive antenna support
- Fully integrating: Dual-stage LNA, SAW filter, TCXO, RTC crystal, GNSS SoC, LDO regulator, RF shield, PMU
- Concurrent tracking of multiple constellations
- Uses GPS, Galileo and GLONASS/BEIDOU, QZSS constellations.
- GPS & Galileo L1 1575.42 frequency, C/A code
- GLONASS L1 FDMA 1598-1606MHz frequency band, SP signal
- BEIDOU B1 1561.098MHz frequency band
- SBAS (WAAS, EGNOS, MSAS and GAGAN)
- Concurrent tracking of multiple constellations
- DGPS capability
- 99 search channels and 33 simultaneous tracking channels
- Ultra-high sensitivity down to -165dBm enabling indoor tracking
- TTFF of < 1s in 50% of trials under hot start conditions
- Low power consumption of  $\leq 15$ mW
- High accuracy of < 2.5m in 50% of trials
- High accuracy of 1.6m@CEP, open sky conditions during 24 hours
- AGPS support: Embedded Assist System (EASY) and Extended Prediction Orbit (EPO) and Hot Still
- Indoor and outdoor multipath and cross-correlation mitigation
- Jamming Rejection 12 multi-tone Active Interference Cancellation (AIC)
- 8 Megabit built-in flash
- Power management modes: Full Power Continuous, Standby, Periodic, and AlwaysLocate<sup>™</sup>
- NMEA commands and data output over UART serial interface
- High update messages rate of 1, 2, 5, and 10Hz
- 1PPS output
- Static navigation
- Single voltage supply 3.3V and backup input
- Ultra-small LGA footprint of 7mm x 7mm
- Ultra-low weight of 0.2g
- Surface Mount Device (SMD)





- Optimized for automatic assembly and reflow equipment
- Operating from -40°C to +85°C
- FCC, CE, VCCI compliant
- RoHS II/REACH compliant

# 3.2. Architecture

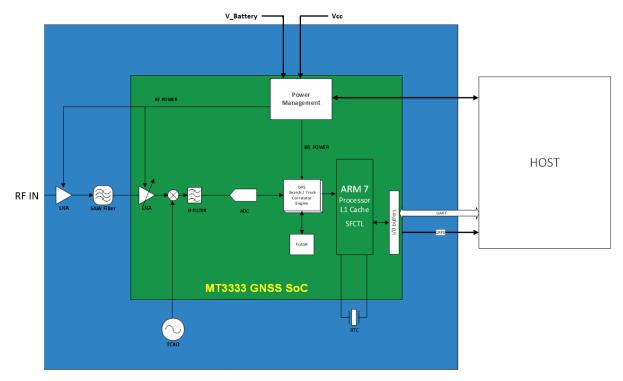


Figure 1. ORG4572-MK05 Architecture

#### • GNSS SAW Filter

Band-Pass SAW filter eliminates out-of-band signals that may interfere with GNSS reception.

GNSS SAW filter is optimized for low Insertion Loss in GNSS band and low Return Loss outside it.

• GNSS LNA

Dual-stage, cascaded LNAs amplify GNSS signals to meet RF down converter input threshold.

Noise Figure optimized design was implemented to provide maximum sensitivity.

• TCXO

Highly stable 26MHz oscillator controls down conversion process in RF block of the GNSS SoC.

Characteristics of this component are important factors for higher sensitivity, shorter TTFF, and better navigation stability.





#### • RTC Crystal

RTC 32.768 KHz quartz crystal with very tight specifications is necessary for maintaining Hot Start and Warm Start capabilities of the module.

#### • RF Shield

RF enclosure avoids external interference from compromising sensitive circuitry inside the module.

RF shield also blocks the module's internal high frequency emissions from being radiated.

#### • MT3333 GNSS SoC

The MT3333, multi-GNSS System on Chip is designed by MediaTek, which is the world's leading digital media solution provider and largest fab-less IC Company in Taiwan.

It is a hybrid positioning processor that combines GPS, GLONASS, GALILEO, BEIDOU, SBAS, QZSS, DGPS, and AGPS to provide a high-performance navigation solution.

MT3333 is a full SoC built on a low-power RF CMOS, incorporating GNSS RF, GNSS baseband, integrated navigation solution software, ARM® processor, and serial flash.

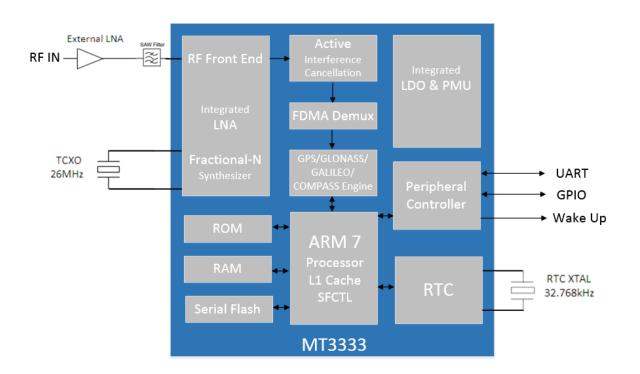


Figure 2. MT3333 System Block Diagram and Peripheral



MT3333 SoC includes the following units:

- GNSS radio subsystem which includes single input, dual receive paths for concurrent GPS, Galileo and GLONASS/BEIDO, mixer with current mode interface between the mixer and multi-modes low pass filter, fractional-N synthesizer, integrated self-calibrating filters, IF VGA with AGC, and high-sample rate ADCs with adaptive dynamic range.
- Measurement subsystem including DSP core for GNSS signals acquisition and tracking, interference scanner and detector, interference removers, multipath and cross-correlation detectors, dedicated DSP code ROM, and DSP cache RAM.
- Measurement subsystem which interfaces the GNSS radio subsystem.
- Navigation subsystem comprising an ARM7® microprocessor system for position, velocity and time solution, program ROM, data RAM, cache and patch RAM, and SPI flash.
- Peripheral Controller subsystem which includes UART Host interface, RTC block, wake up signal option, and GPIO.
- Peripheral Controller subsystem which interfaces a navigation subsystem, and PLL and PMU subsystems.
- Navigation subsystem which interfaces a measurement subsystem.
- PMU subsystem which includes voltage regulators for RF and baseband domains.





# **3.3.** ORG4572-MK05 Features Description:

### **3.3.1.** Constellation Configuration

- GPS, Galileo and GLONASS—default.
- GPS and BEIDOU—available.

## 3.3.2. 1PPS

1PPS (Pulse per Second) signal output available on configuration:

- At 2D Fix only
- At 3D Fix only
- After the first Fix

#### • Always on-default configuration.

The pulse is configurable for required duration, frequency, and active high/low via command.

The pulse may vary 30nS (1  $\sigma$ ). The relationship between the PPS signal and UTC is unspecified.

# **3.3.3.** Static Navigation

Static Navigation is an operational mode in which the receiver freezes the position fix when the speed falls below a threshold (indicating that the receiver is stationary). The course is also frozen, and the speed is reported as zero. The navigation solution is then unfrozen when the speed increases above a threshold. The speed threshold can be set via a command (PMTK 386).

Static Navigation is disabled by default but can be enabled by command. This feature is useful for applications in which very low dynamics are not expected, the classic example being an automotive application.

# 3.3.4. Assisted GPS (AGPS)

Assisted GPS (or Aided GPS) is a method by which TTFF is reduced using information from a source other than broadcast GPS signals. The necessary ephemeris data is calculated either by the receiver itself (locally generated ephemeris) or a server (server-generated ephemeris) and stored in the module.

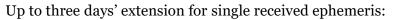
ORG4572-MK05 has EASY, EPO, and HotStill technology to enable Hot Starts even in weak signal conditions and moving state. EPO (Extended Prediction Orbit) is one of MediaTek's innovative proprietary off-line server-based AGPS solutions. The Host is able to use an application to store and load the EPO files into the device. With multi-constellation EPO, the user experience is enhanced by the improved Time-to-First Fix (TTFF) and better first fix accuracy.





#### 3.3.4.1. Locally-generated AGPS (Embedded Assist System – EASY)

The EASY<sup>TM</sup> is an embedded assist system for quick positioning, where the GPS engine calculates and automatically predicts the single emperies (max. up to 3 days), when power is on, and stores the predicted information in the memory. The GPS engine uses this information for positioning if there is not enough information from satellites, so the function is helpful for positioning and TTFF improvement under indoor or urban condition. Backup power (V\_BACKUP) is necessary.



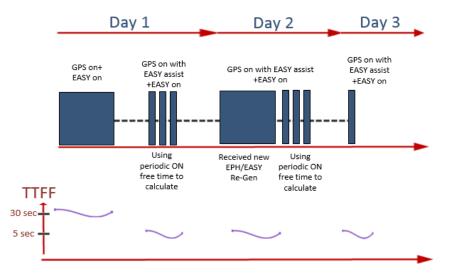


Figure 3. Easy™ TTFF Timing

#### 3.3.4.2. Server-generated AGPS (Extended Prediction Orbit—EPO)

The AGPS (EPO<sup>™</sup>) supplies the predicted Extended Prediction Orbit data to speed the TTFF. Users can download the EPO data to the GNSS engine from the FTP server through the Internet or a wireless network. The GNSS engine uses the EPO data to assist position calculations when the navigation information of satellites is not sufficient, or the operation occurs in a weak signal zone.

The Host could use an application to store and load the EPO files into a device with the improved Time-to-First Fix (TTFF) and better first fix accuracy.

The predicted ephemeris file is obtained from the AGPS server and is injected into the module over serial port 1 (RX1). These predictions do not require local broadcast ephemeris collection and are valid for up to 14 days.

#### **3.3.4.3.** HotStill (Extended Prediction Orbit)

HotStill is one of MTK's innovative proprietary offline, client-based A-GPS solutions, capable of dramatically accelerating GPS TTFF (Time-to-First Fix) in urban canyons or weak signal environments from several minutes to only a few seconds. It works as a background software running on the host processor to predict satellite orbit navigation data and generate Broadcast Ephemeris Extension (BEE) from received broadcast ephemeris as well as no network connection requirements.





# 3.3.5. Quasi-Zenith Satellite System (QZSS)

The three satellites of the Japanese SBAS are in a highly inclined elliptical orbit, which is geosynchronous (not geostationary) and has analemma-like ground tracks. This orbit provides continuous coverage over Japan using only three satellites. Their primary purpose is to provide augmentation to the GPS system, but the signals may also be used for ranging. NMEA reporting for QZSS may be enabled/disabled by the user.

## 3.3.6. Satellite-Based Augmentation System (SBAS)

The ORG4572-MK05 receiver can use Satellite-Based Augmentation System (SBAS) satellites as a source of both differential corrections and satellite range measurements. These systems (WAAS, EGNOS, MSAS, and GAGAN) use geostationary satellites to transmit regional differential corrections via a GNSS-compatible signal. The use of SBAS corrections can significantly improve position accuracy and is enabled by default.

# 3.3.7. Differential GPS (DGPS)

DGPS is a Ground-Based Augmentation System (GBAS) for reducing position errors by applying corrections from a set of accurately surveyed ground stations located over a wide area. These reference stations measure the range to each satellite and compare it to the known-good range. The differences can then be used to compute a set of corrections which are transmitted to a DGPS receiver, either by radio or over the Internet. The DGPS receiver can then send them to the serial port 1 (RX1) using the RTCM SC-104 message protocol. The corrections can significantly improve the accuracy of the position reported to the user. The receiver can accept and apply either the RTCM SC-104 messages or SBAS differential data.

# 3.3.8. Jamming Rejection – Active Interference Cancellation (AIC)

The ORG4572-MK05 detects, tracks, and removes narrow-band interfering signals (jamming signals) without the requirement for external components or tuning. It tracks and removes up to 12 CW (Continuous Wave)-type signals up to -80 dBm (total power signal levels). By default, the jamming detection is enabled but can be disabled by command. This feature is useful both in the design stage and during the production stage for uncovering issues related to unexpected jamming. When enabled, AIC increases current consumption by about 1 mA. The impact on GNSS performance is minimal at low jamming levels. However, at high jamming levels (e.g., -90 to -80 dBm), the RF signal sampling ADC starts to become saturated, after which the GNSS signal levels start to diminish.





### **3.3.9.** Power Management Modes

The ORG4572-MK05 supports operational modes that enable them to provide positioning information at reduced overall current consumption. The availability of GNSS signals in the operating environment is also a factor in the choice of power management modes. The designer can choose a mode that provides the best tradeoff between performance and power consumption.

The power management modes are described below, and can be enabled via command:

- Full Power Continuous—for best GNSS performance
- Power save mode to optimize power consumption:
  - Standby
  - Periodic
  - ♦ AlwaysLocate<sup>TM</sup>

#### **3.3.9.1.** Full Power Continuous Mode

The modules start up in full power continuous mode. This mode uses the acquisition engine at full performance, resulting in the shortest possible TTFF, and the highest sensitivity. It searches for all possible satellites. The receiver then switches to the tracking engine to lower the power consumption when:

- A valid GPS/GNSS position is obtained
- The ephemeris for each satellite in view is valid

To return to Full Power mode (from a low power mode, excluding Backup mode), send the following command: **PMTK225,0** [Just after the module wakes up from its previous sleep cycle].

#### 3.3.9.2. Standby Mode

In this mode, the receiver stops navigation, the internal processor enters standby state, and the current drain at main supply (VCC) is reduced. Standby mode is entered by sending the following command: **PMTK161,0** 

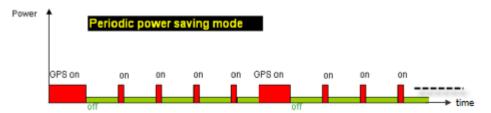
The host can then wake up the module from Standby mode to Full Power mode by sending any byte to the serial port.





#### **3.3.9.3.** Periodic Mode

This mode provides autonomous power on/off with a reduced fix rate to reduce average power consumption. In Periodic Mode, the main power supply VCC is still powered, but power distribution to internal circuits is controlled by the receiver.



#### Figure 4. Periodic Power Saving Mode

Enter Periodic Mode by sending the following command:

PMTK225,<Type>,<Run\_time>,<Sleep\_time>,<2nd\_run\_time>,<2nd\_sleep\_time>\*<checksum>

Where:

- Type = 1 for Periodic backup mode,
- Type = 2 for Periodic standby mode
- Run\_time = Full Power period (ms)
- Sleep\_time = Standby period (ms)
- 2nd\_run\_time = Full Power period (ms) for extended acquisition if GNSS acquisition fails during Run\_time
- 2nd\_sleep\_time = Standby period (ms) for extended sleep if GNSS acquisition fails during Run\_time

```
Example: PMTK225,2,3000,12000,18000,72000
```

for periodic mode with 3 s navigation and 12 s sleep. The acknowledgement response for this command is: **PMTK001,225,3** 

Periodic mode is exited and switched back to Full Power Continuous Mode by sending the command: **PMTK225,0** 

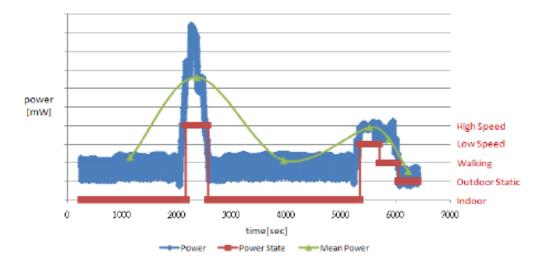
just after the module wakes up from a previous sleep cycle.





#### 3.3.9.4. AlwaysLocate<sup>™</sup> Mode

AlwaysLocate<sup>™</sup> is an intelligent controller of the Periodic Mode. The main power supply VCC is still powered up, but power distribution is internally controlled. Depending on the environment and motion conditions, the module can autonomously and adaptively adjust the parameters of the Periodic Mode, e.g. ON/OFF ratio and fix rate to achieve a balance in positioning accuracy and power consumption. The average current can vary based on conditions.



#### Figure 5. AlwaysLocate<sup>™</sup> Mode: Power vs. Time

Enter AlwaysLocate<sup>™</sup> mode by sending the following NMEA command: **PMTK225,<mode>\*<checksum><CR><LF>** 

Where: mode=9 for AlwaysLocate<sup>TM</sup>

Example:

#### PMTK225,9

The acknowledgement response for the command is:

#### PMTK001,225,3

The user can exit low power modes to Full Power by sending NMEA command:

#### PMTK225,0

just after the module wakes up from its previous sleep cycle.





#### 3.3.9.5. Backup Mode

Backup Mode means a low quiescent power state where receiver operation is stopped.

V\_backup is powered on, but the current consumption is minimal.

After waking up, the receiver uses all internal aiding, including GNSS time, Ephemeris, and Last Position, resulting in the fastest possible TTFF in either hot or warm start modes. During Backup State, the I/O block is powered off. The suggestion is that the host forces its outputs to a low state or to a high-Z state during the Backup State to minimize small leakage currents at the receiver's input signals.

The Current consumption is ~12uA in BACKUP mode (VCC & V\_BACKUP).

#### **Entering Backup Mode:**

#### First Option

Entering to backup mode is performed using a NMEA software command –

PMTK225,4 (+checksum).

**Important:** Before sending the command the FORCE\_ON pin must be tied to ground.

While in Backup mode, the module consumes ~12uA from VCC and V\_BACKUP.

In case the command is sent while the FORCE\_ON is not tied to the ground, the module would enter into an idle state, but not BACKUP mode, and the current consumption would be significantly higher.

The Current consumption is ~12uA in BACKUP mode when FORCE\_ON pin of the module is tied to ground with a jumper. In real life cases, the FORCE\_ON pin is grounded by an active device with the residue resistance different from zero, so the current consumption may be 2-3 times higher i.e. 25uA.

FORCE\_ON must be tied to ground if you want to stay in BACKUP mode.

Example:

#### PMTK225,4 Enter backup mode

NMEA Return feedback:

#### PMTK001,225,3

The module remains in BACKUP mode while FORCE\_ON is tied to ground.

To exit from BACKUP mode, disconnect FORCE\_ON from the ground and pull the FORCE\_On to the high level, wait about 1 second, and then release it to the logic low level again.

**Important:** It is not possible to wake up the module from backup mode using a software command.





#### **Second Option**

The backup mode can be entered by disconnecting the VCC.

Connect the V\_backup to an external battery, and then disconnect the VCC from the module. The module will now enter the backup mode.

To return to Full Power, reconnect the VCC and the module will switch to the active state and acquire a hot start.

During this process, make sure to keep the FORCE\_ON pin at a low level.

### 3.3.10. Configuration Settings

Currently, the configuration settings are erased after turning down the power. Be aware to this issue on power cycles while shutting down the module.



# 3.4. Pad Assignment

#### Table 1. Pin-Out

PAD	NAME	FUNCTION	DIRECTION	LOGIC LEVEL
1	GND	System Ground	Power	
2	RF IN	RF input	Input	50Ω
3	GND	System Ground	Input power	
4	WAKEUP	WAKEUP	Output	2.8V
5	MISO	SPI Data In	Input	2.8V
6	RESET	System Reset– Active Low	Input	2.8V
7	SCK	SPI Clock	Bi-directional	2.8V
8	SCS	SPI Chip Select	Input	2.8V
9	RX	UART Receive (Serial Input)	Input	2.8V
10	MOSI	SPI Data Out	Output	2.8V
11	FORCE ON	Forced full- power mode signal – Active Low	Input	2.8V
12	1PPS	UTC Time Mark	Output	2.8V
13	ТХ	UART Transmit (Serial Output)	Output	2.8V
14	VCC	System Power	Power	3.3V
15	V_BACKUP	Input for battery backup	Input power	2.8-4.2V
16	EINT	External Interrupt for I2C/SPI	Output	2.8V
17	GND	System Ground	Power	
18	CTS	UART Clear to Send/ I2C Clock	Input	2.8V
19	RTS	UART Ready to Send/ I2C Data	Output	2.8V
20	NC	Reserved— Do not connect		



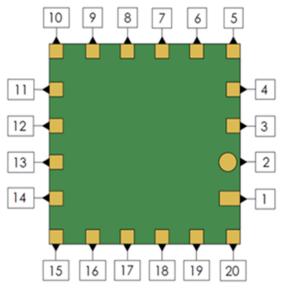


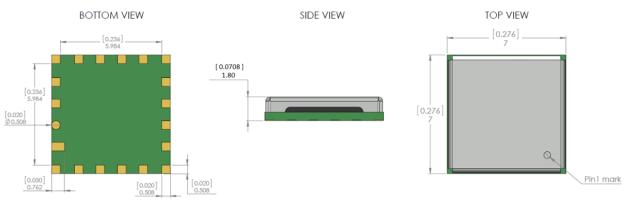
Figure 6. ORG4572-MK05 Top View



4.

# **MECHANICAL SPECIFICATIONS**

- ORG4572-MK05 module has miniature LGA SMD packaging sized at 7mm x 7mm.
- ORG4572—MK05 is built on a PCB assembly enclosed with a metallic RF shield box.
- On the bottom side there are 16+4 SMT pads with a Cu base and ENIG plating.
- The ORG4572—MK05 module supports automated pick and place assembly and reflow soldering processes.



#### Figure 7. Mechanical Drawing

#### Table 2. Mechanical Summary

Dimensions	Length	Width	Height	Weight	
mm	7.0 + 0.2 / -0.05	7.0 + 0.2 / -0.05	1.8 + 0.1 / -0.05	gr	0.2
inch	0.276 + 0.008 / -0.002	0.276 + 0.008 / -0.002	0.0708 + 0.008/ -0.02	oz	0.01



# 5. ELECTRICAL SPECIFICATIONS

# 5.1. Absolute Maximum Ratings

Stresses exceeding Absolute Maximum Ratings may damage the device.

#### **Table 3. Absolute Maximum Ratings**

PARAMETER		SYMBOL	MIN	ΜΑΧ	UNIT
Power Supply Voltage		V <sub>cc</sub>	-0.30	+4.3	V
Backup Battery	Supply Voltage	Vbackup	-0.30	+4.3	V
Power Supply Cu	urrent <sup>1</sup>	lcc		120	mA
RF Input Voltage <sup>2</sup>		V <sub>RF</sub>	-0.30	+3.6	V
I/O Voltage		V <sub>IO</sub>	-0.30	+3.6	v
I/O Source/Sink Current		lıo		+8	mA
ESD Voltage		VIO/RF, HBM Model	(-/+) 1000	(-/+) 3000	V
		VIO/RF, MM Model	(-/+) 100	(-/+) 300	V
RF Power⁵	f <sub>IN</sub> = 1560MHz÷1630MHz	PRF		+10	dBm
RF POwer	f <sub>IN</sub> <1560MHz, >1630MHz	F KF		+30	dBm
Operating Temperature		Тамв	-45	+90	°C
Storage Temperature		T <sub>ST</sub>	-50	+125	°C
Lead Temperature <sup>6</sup>		T <sub>LEAD</sub>	-5	+260	°C

#### Notes:

- 1. Inrush current of up to 100mA for about  $20\mu s$  duration.
- 2. Voltage applied on antenna element.
- 3. Human Body Model (HBM) contact discharge per EIA/JEDEC JESD22-A114D. Step: 500V (+/-).
- 4. Machine Model (MM) contact discharge per EIA/JEDEC JESD22-A115C. Step: 50V (+/-).
- 5. Power is delivered to the antenna element.
- 6. Lead temperature at 1mm from case for 10s duration.





# 5.2. Recommended Operating Conditions

Exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### **Table 4. Recommended Operating Conditions**

PARAMETER	SYMBOL	MODE / PAD	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
Power supply voltage	Vcc	Vcc		+3.00	+3.3	+3.60	V
Backup Battery supply voltage	Vbackup	Vbackup		+2.80	+3.60	+4.30	v
Digital IO Pin Low level input	Vil			-0.3		+0.7	V
Digital IO Pin High level input	Vih			+2.1		+3.6	V
Digital IO Pin Low level output	Vol		lol=2mA	-0.3		+0.4	V
Digital IO Pin High level output	Voh		loh=2mA	+2.4	+2.8	+3.1	V
	Acquisition Icc Tracking Standby Backup	Acquisition	GPS		40		mA
			GPS+GLONASS		45		mA
Power Supply Current <sup>1</sup>		Traching	GPS		28		mA
		Ггаскіпд	GPS+GLONASS		35		mA
		Standby			0.5		mA
		Backup	-	7	12	25	μA
Input Impedance	ZIN		f <sub>IN</sub> = 1575.5MHz		50		Ω
Input Return Loss	RLIN	RF Input	110 - 1373.310112	-7			dB
Input Power Range	PIN		GPS or GLONASS	-165		-110	dBm
Input Frequency Range	f <sub>IN</sub>			1560		1607	MHz
Operating Temperature	Тамв			-40	+25	+85	°C
Storage Temperature <sup>2</sup>	T <sub>ST</sub>			-50	+25	+125	°C
Relative Humidity <sup>3</sup>	R <sub>H</sub>		Т <sub>АМВ</sub>	5		95	%

#### Notes:

1. Typical values under signal conditions of -130dBm and ambient temperature of +25°C and low gain configuration.

Tested on the EVB with 12x12mm passive antenna

- 2. A longer TTFF is expected while operating below -30°C to -40°C.
- 3. Relative Humidity is within Operating Temperature range.





# 6. **PERFORMANCE**

# 6.1. Acquisition Time

TTFF (Time to First Fix)—is the period of time from the module's power-up until the valid position estimation.

### 6.1.1. Hot Start

Hot Start results either from a software reset after a period of continuous navigation or a return from a short idle period that was preceded by a period of continuous navigation.

During Hot Start, all critical data (position, velocity, time, and satellite ephemeris) is valid to the specified accuracy and available in RAM.

### 6.1.2. Signal Reacquisition

Reacquisition follows temporary blocking of GNSS signals.

Typical reacquisition scenario includes driving through a tunnel.

### 6.1.3. Aided Start

Aided Start is a method of effectively reducing TTFF by providing valid satellite ephemeris data.

Aiding can be implemented using Embedded Assist System (EASY), Extended Prediction Orbit (EPO), and HotStill.

### 6.1.4. Warm Start

Warm Start typically results from user-supplied position and time initialization data or continuous RTC operation with an accurate last known position available in RAM.

In this state, position and time data are present and valid, but satellite ephemeris data validity has expired.

### 6.1.5. Cold Start

Cold Start occurs when satellite ephemeris data and position and time data are unknown.

A typical Cold Start scenario includes first power application.



OPERATION <sup>1</sup>	MODEM	VALUE	UNIT
Hot Start		< 1	S
Aided Start		< 3	S
Warm Start	GPS + GLONASS	< 26	S
	GPS	< 29	S
Cold Start	GPS + GLONASS	< 23	S
	GPS	< 31	S
Signal Reacquisition		< 3	S

#### Notes:

- 1. EVK is 24-hrs. Static under signal conditions of -130dBm and ambient temperature of +25°C.
- 2. Outage duration  $\leq$  30s.
- 3. Dependent on aiding data connection speed and latency.
- 4. Tested on the EVB with 12x12mm passive antenna.

# 6.2. Sensitivity

### 6.2.1. Tracking

Tracking is an ability of the receiver to maintain valid satellite ephemeris data. During tracking, the receiver may stop outputting valid position solutions. Tracking sensitivity is defined as the minimum GNSS signal power required for tracking.

### 6.2.2. Reacquisition

Reacquisition follows the temporary blocking of GNSS signals. Reacquisition sensitivity is defined as the minimum GNSS signal power

# required for reacquisition.

### 6.2.3. Navigation

During navigation, the receiver consequently outputs valid position solutions. Navigation sensitivity is defined as the minimum GNSS signal power required for reliable navigation.

### 6.2.4. Hot Start

Hot Start sensitivity is defined as the minimum GNSS signal power required for a valid position solution under Hot Start conditions.





### 6.2.5. Aided Start

Aided Start sensitivity is defined as the minimum GNSS signal power required for a valid position solution following the aiding process.

### 6.2.6. Cold Start

Cold Start sensitivity is defined as the minimum GNSS signal power required for valid position solution under Cold Start conditions. It is sometimes referred to as the ephemeris decode threshold.

#### Table 6. Sensitivity

OPERATION1	MODE	VALUE	UNIT
Tracking	GPS	-165	dBm
	GLONASS	-165	dBm
Navigation	GPS	-163	dBm
	GLONASS	-163	dBm
Reacquisition <sup>2</sup>	GPS+GLONASS	-160	dBm
Hot Start*	GPS+GLONASS	-163	dBm
Aided Start	GPS+GLONASS	-160	dBm
Cold Start	GPS+GLONASS	-148	dBm

\*\* The above values have been tested at an update rate of 1 Hz.

While working at a higher update rate there is some signal degradation.

# 6.3. Received Signal Strength

#### Table 7. Received Signal Strength

PARAMETER4	VALUE	UNIT
C/N0	45	dB-Hz

#### Notes:

- 1. EVK is static, ambient temperature is  $+25^{\circ}$ C, and RF signals are conducted.
- 2. Outage duration  $\leq$  30s.
- 3. Aiding using Broadcast Ephemeris (Ephemeris Push<sup>™</sup>) or Extended Ephemeris (CGEE<sup>™</sup> or SGEE<sup>™</sup>).
- 4. Average C/No reported for 4 SVs, EVK is 24-hrs. Static, outdoor, ambient temperature is +25°C.



# 6.4. Power Consumption

#### **Table 8. Power Consumption**

OPERATION1	MODE	VALUE	UNIT
Acquisition	GPS	132	mW
	GPS + GLONASS	148.5	mW
Tracking	GPS	92.4	mW
	GPS + GLONASS	115.5	mW
Standby State		1.65	mW
Backup State		39.6	uW

#### Note:

1. Typical values under conducted signal conditions of -130dBm and ambient temperature of +25°C. Measured voltage is 3.28V.

# 6.5. Position Accuracy

#### Table 9. ORG4572-MK05 Position Accuracy

PARAMETER	CONSTELLATION	CEP (m)
Horizontal Position Accuracy	GPS	2.5
Horizontal Position Accuracy	Glonass	2.6
Horizontal Position Accuracy	BeiDou	10.2
Horizontal Position Accuracy	GPS + Glonass	2.5
Horizontal Position Accuracy	GPS + BeiDou	2.5

#### Notes:

- 1. Module is static under signal conditions of -130dBm. Ambient temperature is +25°C.
- 2. EVK is 24-hrs. Static, ambient temperature is +25°C.
- **3.** Speed over ground  $\leq$  30m/s.

# 6.6. Dynamic Constraints

#### **Table 10. Dynamic Constraints**

PARAMETER	METRIC	IMPERIAL
Velocity	515m/s	1,000 knots
Altitude	10,000m	32,808 ft
Altitude Balloon Mode	80,000m	262,467 ft
Acceleration	4	g

**Note: 1.** Standard dynamic constrains according to regulatory limitations.





# 7. INTERFACE

# 7.1. Power Supply

It is recommended to keep the power supply on all the time in order to keep the RTC block active and keep satellite data in RAM for fastest possible TTFF. When the VCC is removed, settings are reset to factory default and the receiver performs a Cold Start on the next power up.

## 7.1.1. Nominal VCC = 3.3V

VCC is 3.3v DC and must be provided from a regulated power supply.

During tracking, the processing is less intense compared to acquisition, therefore power consumption is lower.

Filtering is important to manage high alternating current flows on the power input connection. An additional LC filter on ORG4572-MK05 power input may be required to reduce system noise.

The high rate of ORG4572-MK05 input current change requires low ESR bypass capacitors.

Additional higher ESR output capacitors can provide input stability damping.

The ESR and size of the output capacitors directly define the output ripple voltage with a given inductor size. Large low ESR output capacitors are beneficial for low noise. Voltage ripple below 40mVPP is allowed. Higher voltage ripple may compromise ORG4572 performance.

## 7.1.2. Ground

A ground pad must be connected to the host PCB Ground with the shortest possible trace or via multiple VIAs.

# 7.2. Control Interface

ORG4572-MK05 has a three host interfaces: UART, I2C and SPI. The switching between the interfaces is by firmware update.

## 7.2.1. UART—Host Interface

The ORG4572-MK05 module has the following standard UART ports:

## 7.2.1.1. TX

TX used for GPS data reports. Output logic high voltage level is 2.8V. The TX serial data line outputs NMEA serial data at a default bit rate of 9600 bps.

When no serial data is output, the TX data line idles high.





## 7.2.1.2. RX

RX is used for receiver control. The Input logic high voltage level is 2.8V. The RX data line accepts NMEA commands at a default bit rate of 9600 bps. When the receiver is powered down, do not back drive this or any other GPIO line.

The idle state for serial data from the host computer is logic 1.

## 7.2.2. I2C

The I2C interface in enabled by default starting from F.W. version 5.1.1. I2C host interface features are:

- I2C Slave mode—host initiates clock and data, operating speed 400kbps.
- ORG4572-MK05 supports 7-bit I 2C address.
- I2C default slave address '0x10'.
- Individual Tx FIFO buffer length of 255 bytes. Master can read one I2C data packet of max. 255 bytes at a time.

In order to read entire NMEA packet of one second, the master must read several I2C data packets and extract valid NMEA data. After reading one I2C data packet, it sleeps for 2ms before reading the next packet. In the event that the entire packet of 1 second was read, wait for a longer period for the next NMEA packet.

## 7.2.3. SPI

The ORG4572-MK05 will work in a slave mode, while the master can read one SPI data packet with 255 bytes max. each time.

- To read one NMEA packet, the master should send padding bytes ("oxFF") for receiving NMEA data from the slave
- To read the entire NMEA packet of one second, the master should read several SPI data packets and extract valid NMEA data from them.
- Baud rate is up to 700kbit/s

for more detailed information, please refer to "MTK\_SPI application notes" document.

**Note:** the ORG4572-MK05 with SPI option has a different part number. Please refer to the "Ordering information" (section 15)





## 7.2.4. Data Interface

### 7.2.4.1. Force-On

FORCE-ON is an input pin which controls the power states of the module. There are two possible states for this pin – LOW and HIGH.

#### LOW state:

If we run the command "PMTK225,4", the module will enter a Backup mode. In this mode, the module enters the lowest power consumption mode.

\*Return to full power mode:

- Set FORCE\_ON to HIGH
- Wait 1sec
- Set FORCE\_ON to LOW

If we run the command "PMTK225,1,....", the module will enter a periodic backup mode.

\*Return to full power mode:

- Set FORCE\_ON to HIGH
- Run command "PMTK225,0"
- Wait for 100ms
- Set FORCE\_ON to LOW

#### **HIGH state:**

- Note in this state, the module can't enter a backup mode.
- If we run the command "PMTK225,4", the module will enter a standby-stop mode.

There are two ways to return to full power mode:

First way:

• Send any byte on the Rx line

Second way:

- Set FORCE\_ON to LOW
- Wait 1sec
- $\circ$  Set FORCE\_ON to HIGH.

### 7.2.4.2. RESET

In addition, to the NMEA command for reset—\$PMTK104\*37, external reset is available through the ("RESET") pad. Active low signal. Signal logic level of 2.8V.

The module continuously monitors the VCC supply and issues an internal hardware reset if the voltage drops below  $2.7 (\pm 0.1)$  V. This reset protects the memory from accidental writes during a power down condition. To prevent this, the supply must be regulated to be within the 2.8-4.3 voltage range, inclusive of load regulation and power supply noise and ripple. Noise and ripple outside of these limits can affect positioning sensitivity and risks tripping the internal voltage supervisors, thereby shutting down the module unexpectedly.



Regulators with good load regulation are recommended to prevent power supply glitches as the receiver transitions between power states.

### 7.2.4.3. 1PPS

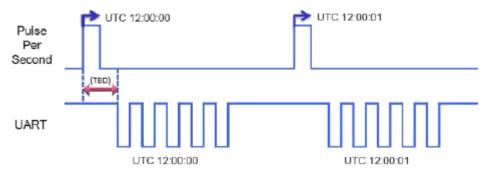
Pulse-Per-Second (PPS) output provides a pulse signal for timing purposes.

The pulse is configurable for required duration, frequency and active high/low via command.

The pulse may vary 30 nS (1  $\sigma$ ). The relationship between the PPS signal and UTC is unspecified.

To enable or disable this functionality, use the Proprietary Mediatek command PMTK255:

```
PMTK255,1 => enable PPS
PMTK255,0 => disable PPS
```



#### Figure 8. 1PPS and UTC

1PPS supports a 1Hz NMEA output, but at a baud rate of 9600 bps, if there are many NMEA sentences output, per second transmission may exceed one second.

### 7.2.4.4. Wakeup

When the ORG4572-MK05 is on (full power), the output is high, at the 3.3V level.

When the ORG4572-MK05 in on Standby or backup mode the output is low (ground).

The typical output voltage is 3.3V.

On low power modes (Periodic and AlwaysLocate), when the ORG4572-MK05 is off, the wakeup level is low (and the wakeup returns to high level when the module returns to full power).



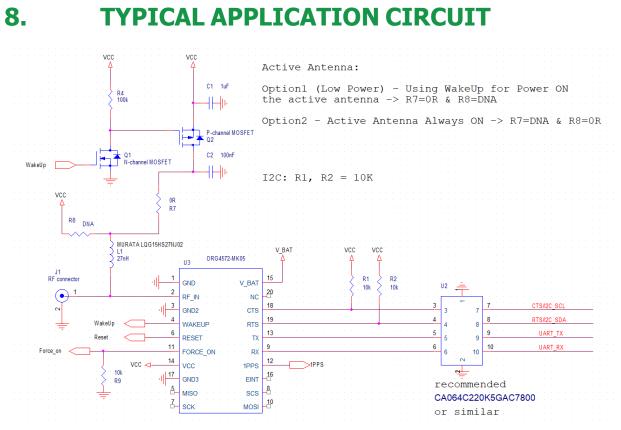
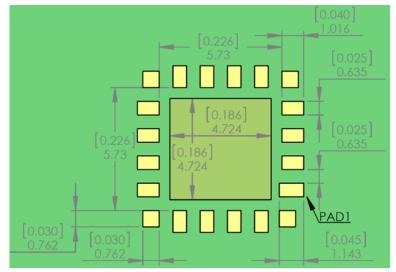


Figure 9. Reference Schematic Diagram



# 9. **RECOMMENDED PCB LAYOUT**

# 9.1. Footprint



#### Figure 10. Footprint

The Ground paddle at the middle should be connected to the main Ground plane by multiple VIAs.

The Ground paddle at the middle must be solder-masked.

The Silk print of the module's outline is highly recommended for SMT visual inspection.

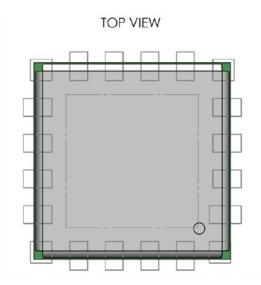
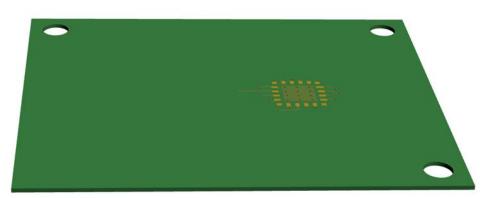


Figure 11. Module Hosted on Footprint





.

## Figure 12. Host PCB

# 9.2. RF Trace

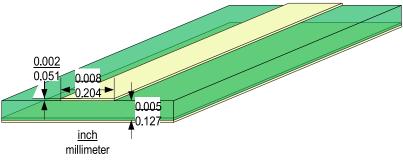
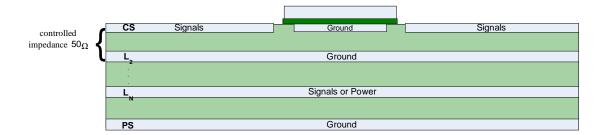


Figure 13. Typical Microstrip PCB Trace on Fr-4 Substrate

# 9.3. PCB Stack-Up



### Figure 14. Typical PCB Stack-Up





Switching and high-speed components, traces, and VIAs must be kept away from the ORG4572-MK05 module.

Signal traces to/from module must have minimum length.

The recommended minimal distance from adjacent active components is 3mm.

Ground pads must be connected to the host PCB Ground with the shortest possible traces or VIAs.

In the event of a tight integration constraint or co-location with adjacent highspeed components like CPU or memory, high frequency components like transmitters, clock resonators or oscillators, LCD panels or CMOS image sensors, contact OriginGPS for application-specific recommendations.





# **10. DESIGN CONSIDERATIONS**

# 10.1. Antenna

Antennas for GPS, Galileo, and GLONASS have a wider bandwidth than pure GPS antennas.

Some wideband antennas may not have a good axial ratio to block reflections of RHCP GPS, Galileo, and GLONASS signals. These antennas have lower rejection of multipath reflections and tend to degrade the overall performance of the receiver.

## **10.1.1.** Passive Antenna

A design with a passive antenna requires RF layout skills and can be challenging.

## **10.1.2.** Active Antenna

While designing with active antenna, consider using WAKEUP output to control auxiliary DC bias.

## 10.2. RF

The ORG4572-MK05 Spider module operates with received signal levels down to -167dBm and can be affected by high absolute levels of RF signals, moderate levels of RF interference near the GNSS bands, and by low levels of RF noise in GNSS band.

RF interference from nearby electronic circuits or radio transmitters can contain enough energy to desensitize ORG4572-MK05. These systems may also produce levels of energy outside of GNSS band, high enough to leak through RF filters and degrade the operation of the radios in ORG4572-MK05.

This issue becomes more critical in small products, where there are industrial design constraints. In that environment, transmitters for Wi-Fi, Bluetooth, RFID, cellular and other radios may have antennas physically close to the GNSS receiver antenna.

To prevent degraded performance of ORG4572-MK05, OriginGPS recommends performing EMI/jamming susceptibility tests for radiated and conducted noise on prototypes and assessing risks of other factors.

Contact OriginGPS for application-specific recommendations and design review services.





Command ID	Description			
PMTK000	Test. This command will be echoed back to the sender (for testing the communications link).			
PMTK101	Perform a HOT start			
PMTK102	Perform a WARM start			
PMTK103	Perform a COLD start			
PMTK104	Perform a system reset (erasing any stored almanac data) and then a COLD start			
PMTK120	Erase aiding data stored in flash memory			
PMTK127	Erase EPO data stored in flash memory			
PMTK161,0	Standby - Stop mode			
PMTK161,1	Standby - Sleep mode			
PMTK251,Baudrate	Set NMEA Baudrate			
PMTK313,0	Disable SBAS feature			
PMTK313,1	Enable SBAS feature			
PMTK353,1,0,0,0,0	Enable GPS only mode			
PMTK353,0,1,0,0,0	Enable GLO only mode			
PMTK353,0,0,0,0,1	Enable BDS only mode			
PMTK353,1,1,0,0,0	Enable GPS and GLO mode			
PMTK353,1,0,0,0,1	Enable GPS and BDS mode			





The FW stored in the internal Flash memory may be upgraded via the serial port TX/RX pads. In order to update the FW, the following steps should be taken to perform reprogramming:

- 1. Remove all power to the module.
- 2. Connect the serial port to a PC.
- 3. Apply main power.
- 4. Run the software utility to re-flash the module. Clearing the entire flash memory is strongly recommended prior to programming.
- 5. Upon successful completion of re-flashing, remove the main power to the module for a minimum of 10 seconds.
- 6. Apply the main power to the module.
- 7. Verify the module has returned to the normal operating state.





# **12. HANDLING INFORMATION**

## **12.1.** Moisture Sensitivity

ORG4572-MK05 modules are MSL 3 designated devices according to IPC/JEDEC J-STD-033B standard.

The Module in a sample or bulk package must be baked prior to assembly at  $125^{\circ}$ C for 48 hours.

# 12.2. Assembly

The module supports automatic pick-and-place assembly and reflow soldering processes.

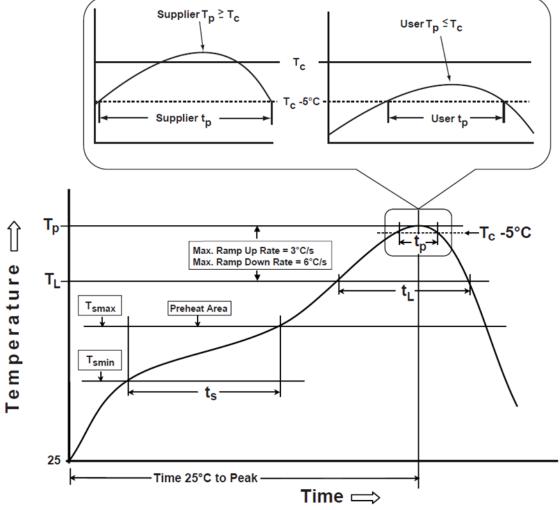
The suggested solder paste stencil is 5 mil to ensure sufficient solder volume.

# 12.3. Soldering

Reflow soldering of the module always on the component side (Top side) of the host PCB according to standard IPC/JEDEC J-STD-020D for LGA SMD.

Avoid exposure of ORG4572-MK05 to a face-down reflow soldering process.





### Figure 15. Recommended Soldering Profile

Referred temperature is measured on the top surface of the package during the entire soldering process.

The suggested peak reflow temperature is 245°C for 30 sec. for Pb-Free solder paste.

The actual board assembly reflow profile must be developed individually per furnace characteristics.

Reflow furnace settings depend on the number of heating/cooling zones, type of solder paste/flux used, board design, component density, and packages used.



SYMBOL	PARAMETER	MIN	ТҮР	MAX	UNIT
тс	Classification Temperature		245		°C
ТР	Package Temperature			245	°C
TL	Liquidous Temperature		217		°C
TS	Soak/Preheat Temperature	150		200	°C
tS	Soak/Preheat Time	60		120	S
tL	Liquidous Time	60		150	S
tP	Peak Time		30		S

#### **Table 12. Soldering Profile Parameters**

## 12.4. Cleaning

If flux cleaning is required, the module is capable of withstanding a standard cleaning process in a vapor degreaser with the Solvon® n-Propyl Bromide (NPB) solvent and/or washing in DI water.

Avoid a cleaning process in an ultrasonic degreaser since specific vibrations may cause performance degradation or destruction of internal circuitry.

## 12.5. Rework

If localized heating is required to rework or repair the module, precautionary methods are required to avoid exposure to solder reflow temperatures that can result in permanent damage to the device.

## 12.6. ESD Sensitivity



This product is an ESD sensitive device and must be handled with care.

## 12.7. Safety Information

Incorrect handling and use can cause permanent damage to the product.

## **12.8.** Disposal Information

This product must not be treated as household waste.

For more detailed information about recycling electronic components contact your local waste management authority.





# **13.** COMPLIANCE

The following standards are applied on the production of ORG4572-MK05 modules:

- IPC-6011/6012 Class2 for PCB manufacturing
- IPC-A-600 Class2 for PCB inspection
- IPC-A-610D Class2 for SMT acceptability

ORG4572-MK05 modules are manufactured in ISO 9001:2008 accredited facilities.

ORG4572-MK05 modules are manufactured in ISO 14001:2004 accredited facilities.

ORG4572-MK05 modules are manufactured in OHSAS 18001:2007 accredited facilities.

ORG4572-MK05 modules are designed, manufactured, and handled in compliance with the Directive 2011/65/EU of the European Parliament and of the Council of June 2011 on the Restriction of the use of certain Hazardous Substances in electrical and electronic equipment, referred as RoHS II.



ORG4572-MK05 modules are manufactured and handled in compliance with

the applicable substance bans as of Annex XVII of Regulation 1907/2006/EC on Registration, Evaluation, Authorization and Restriction of Chemicals including all amendments and candidate list issued by ECHA, referred as REACH.



ORG4572-MK05 modules comply with the following EMC standards:

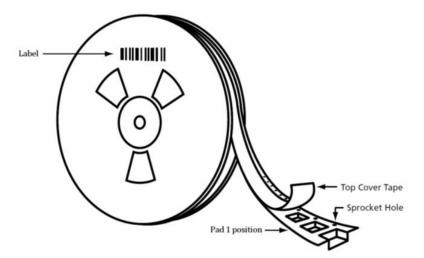
- EU CE EN55022:06+A1(07), Class B
- US FCC 47CFR Part 15:09, Subpart B, Class B
- JAPAN VCCI V-3/2006.04 (6 년 📧



# 14. PACKAGING AND DELIVERY

## 14.1. Appearance

ORG4572-MK05 modules are delivered in reeled tapes for an automatic pickand-place assembly process.



#### Figure 16. Module Position

ORG4572-MK05 modules are packed in two different reel types (TR1 and TR2).

### Table 13. Reel Quantity

SUFFIX	IX TR1 TR2	
Quantity	500	2000

Reels are dry-packed with a humidity indicator card and desiccant bag according to IPC/JEDEC J-STD-033B standard for MSL 3 devices.

Reels are vacuum-sealed inside anti-static moisture barrier bags.

Sealed reels are labeled with an MSD sticker providing information about:

- MSL
- Shelf life
- Reflow soldering peak temperature
- Seal date

Sealed reels are packed inside cartons.

Reels, reel packs, and cartons are labeled with a sticker providing information about:

- Description
- Part number
- Lot number
- Customer PO number
- Quantity
- Date code

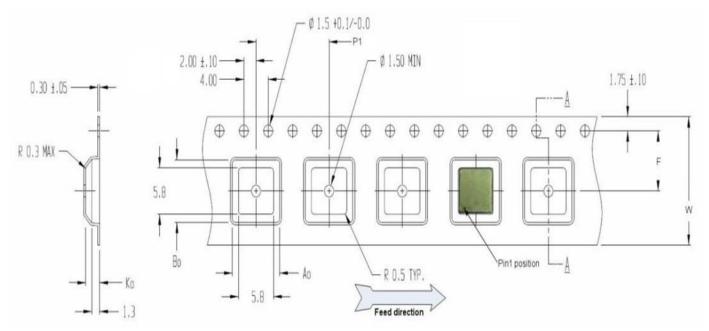




# 14.2. Carrier Tape

Carrier tape material—polystyrene with carbon (PS+C).

Cover tape material—polyester-based film with a heat-activated adhesive coating layer.





	ММ	INCH		
A0	8.3 ± 0.1	0.327 ± 0.004		
B0	8.3 ± 0.1	0.327 ± 0.004		
К0	2.7 ± 0.1	0.106 ± 0.004		
F	7.5 ± 0.1	0.295 ± 0.004		
P1	12.0 ± 0.1	0.472 ± 0.004		
W	16.0 ± 0.3	0.630 ± 0.012		

#### **Table 14. Carrier Tape Dimensions**



# 14.3. Reel

Reel material—antistatic plastic.

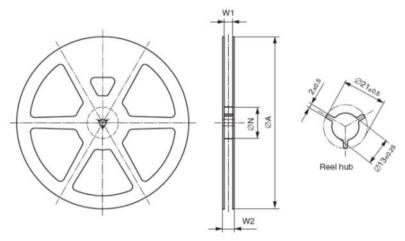


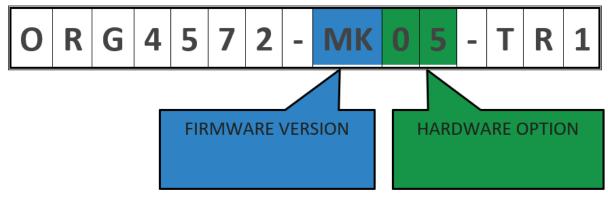
Figure 18. Reel

SUFFIX	т	TR1		TR2		
	ММ	INCH	мм	ММ		
ØA	178.0 ± 1.0	7.00 ± 0.04	330.0 ± 2.0	13.0 ± 0.08		
ØN	60.0 ± 1.0	2.36 ± 0.04	102.0 ± 2.0	4.02 ± 0.08		
W1	16.7 ± 0.5	0.66 ± 0.02	16.7 ± 0.5	0.66 ± 0.02		
W2	19.8 ± 0.5	0.78 ± 0.02	22.2 ± 0.5	0.87 ± 0.02		

#### **Table 15. Reel Dimensions**



# **15. ORDERING INFORMATION**



### Figure 19. Ordering Options

#### **Table 16. Orderable Devices**

PART NUMBER	FW VERSION	HW OPTION	VCC RANGE	PACKAGING	SPQ
ORG4572-MK05-TR1	МК	05	3.3V	REELED TAPE	500
ORG4572-MK05-TR2	МК	05	3.3V	REELED TAPE	2000
ORG4572-MK05-TR1-SPI	МК	05	3.3V	REELED TAPE	500
ORG4572-MK05-TR2-SPI	МК	05	3.3V	REELED TAPE	2000
ORG4572-MK05-UAR	МК	05	5V USB	EVALUATION KIT	1
ORG4572-MK05-UAR-SPI	МК	05	5V USB	EVALUATION KIT	1
ORG4572-MK05-USB	МК	05	5V USB	GNSS ON A STICK KIT	1
ORG4572-MK05-USB-SPI	МК	05	5V USB	GNSS ON A STICK KIT	1

The default constellations are GPS, GLONASS, and Galileo.

GPS and BEIDOU constellations are also available.



# Appendix A. ORG4572-MK05

The ORG4572-MK05 version has an option to connect a coin battery (for example ECR2025 coin battery) to provide power in Backup Mode. The minimum voltage that the backup battery can support is 2.8V.

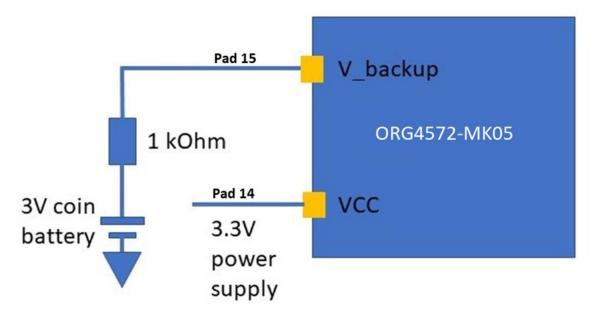
With a battery connection, after waking up, the receiver uses:

1. All internal aiding, including RTC time, Ephemeris, and Last Position, resulting in the fastest possible TTFF in either hot or warm start modes.

2. Configuration settings stored in flash after turning power off.

To keep alive the RTC time, the following circuit implementation using a 3V coin battery, can be used.

In addition, consider using a charger for the battery or separating the VCC and V\_BACKUP by using a controlled LDO for each one.



### Figure 20. Battery Backup Implementation

If a battery is not connected to pad 15 in ORG4572-MK05, connection between pads 14 and 15 is essential in order to operate the module.